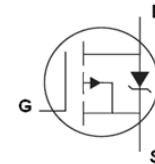
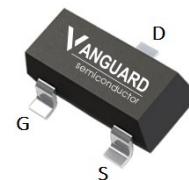


## Features

- P-Channel, -2.5V Logic Level Control
- Enhancement mode
- Low on-resistance  $R_{DS(on)}$  @  $V_{GS}=-2.5$  V
- Fast Switching
- Pb-free lead plating; RoHS compliant; Halogen Free

|                                    |     |    |
|------------------------------------|-----|----|
| $V_{DS}$                           | -20 | V  |
| $R_{DS(on),TYP}$ @ $V_{GS}=-4.5$ V | 25  | mΩ |
| $R_{DS(on),TYP}$ @ $V_{GS}=-2.5$ V | 34  | mΩ |
| $I_D$                              | -6  | A  |

**SOT23-3L**

**Halogen-Free**


| Part ID  | Package Type | Marking | Tape and reel information |
|----------|--------------|---------|---------------------------|
| VS2522AL | SOT23-3L     | VS14    | 3000pcs/reel              |

### Maximum ratings, at $T_A = 25$ °C, unless otherwise specified

| Symbol         | Parameter                                  | Rating         | Unit |
|----------------|--|----------------|------|
| $V_{(BR)DSS}$  | Drain-Source breakdown voltage             | -20            | V    |
| $V_{GS}$       | Gate-Source voltage                        | ±12            | V    |
| $I_S$          | Diode continuous forward current           | $T_A = 25$ °C  | A    |
| $I_D$          | Continuous drain current @ $V_{GS}=-4.5$ V | $T_A = 25$ °C  | A    |
|                |  | $T_A = 100$ °C | A    |
| $I_{DM}$       | Pulse drain current tested ①               | $T_A = 25$ °C  | A    |
| $P_D$          | Maximum power dissipation                  | $T_A = 25$ °C  | W    |
| MSL            |  | Level 3        |      |
| $T_{STG}, T_J$ | Storage and junction temperature range     | -55 to 150     | °C   |

### Thermal Characteristics

| Symbol          | Parameter                               | Typical | Unit |
|-----------------|---|---------|------|
| $R_{\theta JL}$ | Thermal Resistance, Junction-to-Lead    | 60      | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient | 100     | °C/W |



## Typical Electrical Characteristics

| Symbol  | Parameter  | Condition   | Min. | Typ. | Max.      | Unit             |
|---|--|---|------|------|-----------|------------------|
| <b>Static Electrical Characteristics @ <math>T_j = 25^\circ\text{C}</math> (unless otherwise stated)</b>  |  |   |      |      |           |                  |
| $V_{(\text{BR})\text{DSS}}$   | Drain-Source Breakdown Voltage                             | $V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$   | -20  | --   | --        | V                |
| $I_{\text{DSS}}$  | Zero Gate Voltage Drain Current( $T_j=25^\circ\text{C}$ )  | $V_{\text{DS}}=-20\text{V}, V_{\text{GS}}=0\text{V}$  | --   | --   | -1        | $\mu\text{A}$    |
|   | Zero Gate Voltage Drain Current( $T_j=125^\circ\text{C}$ ) | $V_{\text{DS}}=-20\text{V}, V_{\text{GS}}=0\text{V}$  | --   | --   | -100      | $\mu\text{A}$    |
| $I_{\text{GSS}}$  | Gate-Body Leakage Current                                  | $V_{\text{GS}}=\pm 12\text{V}, V_{\text{DS}}=0\text{V}$   | --   | --   | $\pm 100$ | nA               |
| $V_{\text{GS(TH)}}$   | Gate Threshold Voltage                                     | $V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=-250\mu\text{A}$   | -0.4 | -0.6 | -1        | V                |
| $R_{\text{DS(ON)}}$   | Drain-Source On-State Resistance ②                         | $V_{\text{GS}}=-4.5\text{V}, I_{\text{D}}=-4\text{A}$   | --   | 25   | 32        | $\text{m}\Omega$ |
|   |  | $V_{\text{GS}}=-2.5\text{V}, I_{\text{D}}=-2\text{A}$   | --   | 34   | 44        | $\text{m}\Omega$ |
| <b>Dynamic Electrical Characteristics @ <math>T_j = 25^\circ\text{C}</math> (unless otherwise stated)</b> |  |   |      |      |           |                  |
| $C_{\text{iss}}$  | Input Capacitance  | $V_{\text{DS}}=-10\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$   | 1100 | 1630 | 2100      | pF               |
| $C_{\text{oss}}$  | Output Capacitance   |   | 90   | 170  | 250       | pF               |
| $C_{\text{rss}}$  | Reverse Transfer Capacitance                               |   | 80   | 140  | 200       | pF               |
| $R_g$   | Gate Resistance  | $f=1\text{MHz}$   | --   | 8.4  | --        | $\Omega$         |
| $Q_g$   | Total Gate Charge  | $V_{\text{DS}}=-10\text{V}, I_{\text{D}}=-4\text{A}, V_{\text{GS}}=-4.5\text{V}$                                  | --   | 20   | --        | nC               |
| $Q_{\text{gs}}$   | Gate-Source Charge   |   | --   | 7    | --        | nC               |
| $Q_{\text{gd}}$   | Gate-Drain Charge  |   | --   | 7.5  | --        | nC               |
| <b>Switching Characteristics</b>  |  |   |      |      |           |                  |
| $t_{\text{d(on)}}$  | Turn-on Delay Time   | $V_{\text{DD}}=-10\text{V}, I_{\text{D}}=-4\text{A}, R_{\text{G}}=3\Omega, V_{\text{GS}}=-4.5\text{V}$            | --   | 0.75 | --        | $\mu\text{s}$    |
| $t_r$   | Turn-on Rise Time  |   | --   | 1.2  | --        | $\mu\text{s}$    |
| $t_{\text{d(off)}}$   | Turn-Off Delay Time  |   | --   | 4.1  | --        | $\mu\text{s}$    |
| $t_f$   | Turn-Off Fall Time   |   | --   | 3.9  | --        | $\mu\text{s}$    |
| <b>Source- Drain Diode Characteristics@ <math>T_j = 25^\circ\text{C}</math> (unless otherwise stated)</b> |  |   |      |      |           |                  |
| $V_{\text{SD}}$   | Forward on voltage   | $I_{\text{SD}}=-4\text{A}, V_{\text{GS}}=0\text{V}$   | --   | -0.8 | -1.2      | V                |
| $t_{\text{rr}}$   | Reverse Recovery Time                                      | $T_j=25^\circ\text{C}, I_{\text{SD}}=-4\text{A}, V_{\text{GS}}=0\text{V}, \frac{di}{dt}=-100\text{A}/\mu\text{s}$ | --   | 18   | --        | ns               |
| $Q_{\text{rr}}$   | Reverse Recovery Charge                                    |   |      | 11   |           | nC               |

NOTE:

① Repetitive rating; pulse width limited by max junction temperature.

② Pulse width  $\leq 300\mu\text{s}$ ; duty cycle  $\leq 2\%$ .



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-20V/-6A P-Channel Advanced Power MOSFET

## Typical Characteristics

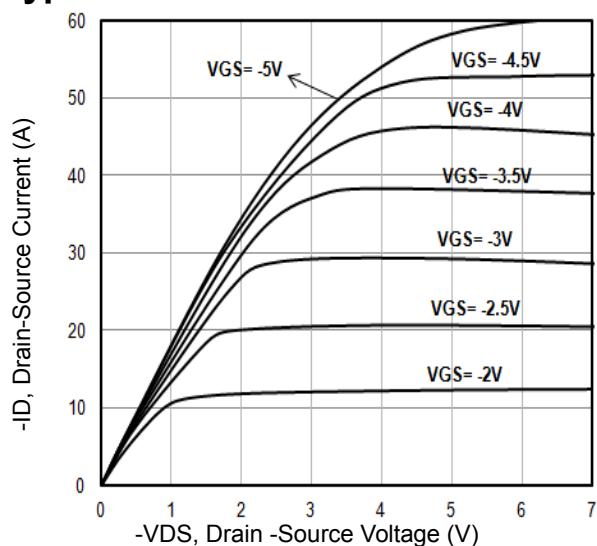


Fig1. Typical Output Characteristics

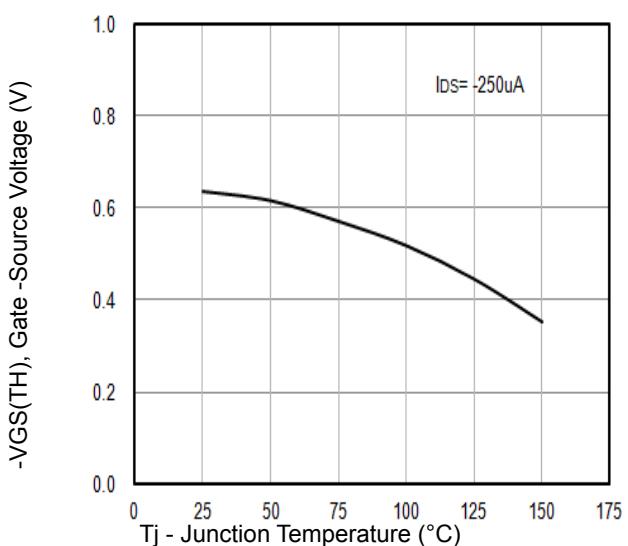


Fig2.  $-VGS(TH)$  Gate -Source Voltage Vs.  $T_j$

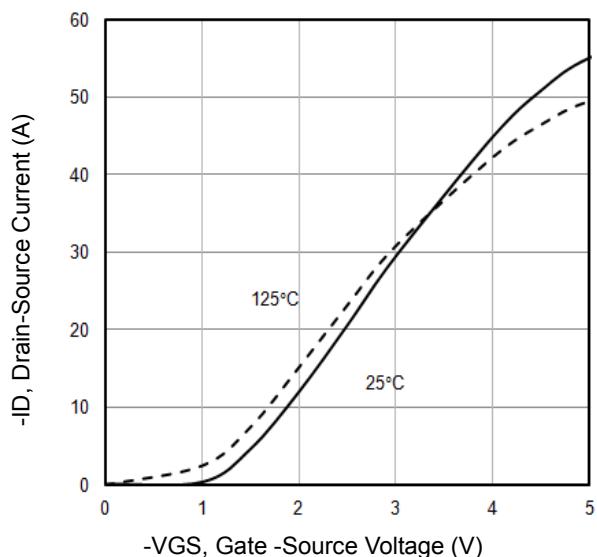


Fig3. Typical Transfer Characteristics

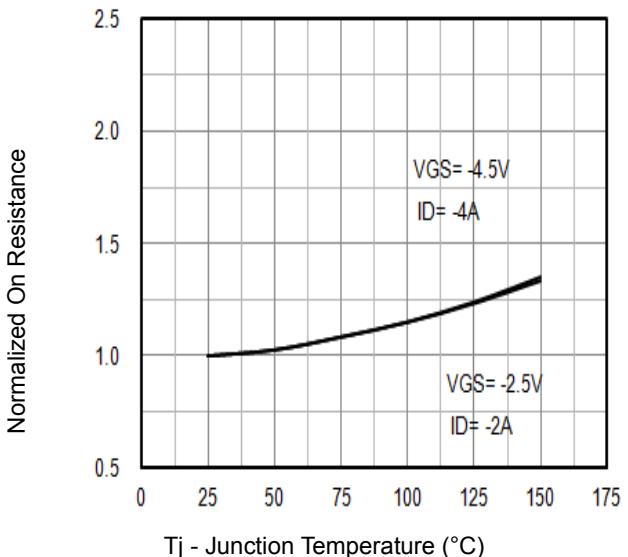


Fig4. Normalized On-Resistance Vs.  $T_j$

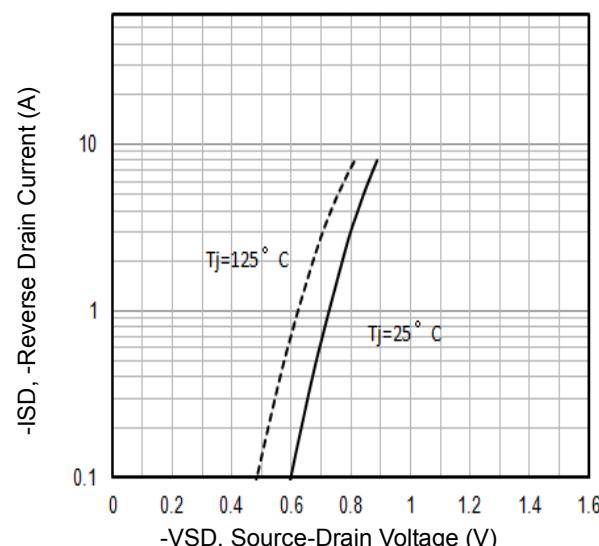


Fig5. Typical Source-Drain Diode Forward Voltage

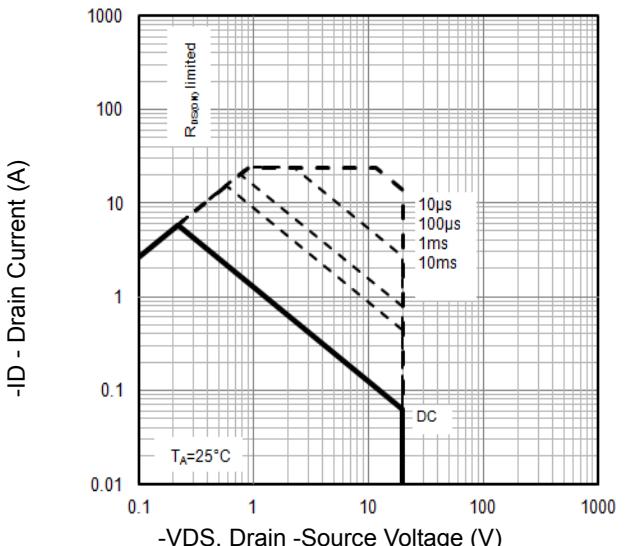


Fig6. Maximum Safe Operating Area



## Typical Characteristics

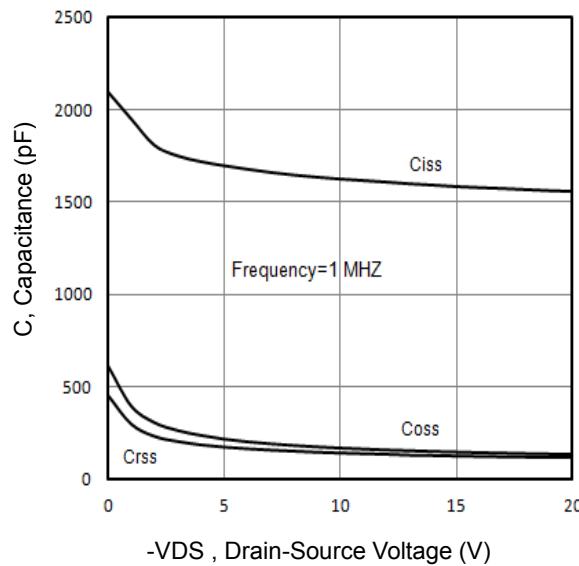


Fig7. Typical Capacitance Vs.Drain-Source Voltage

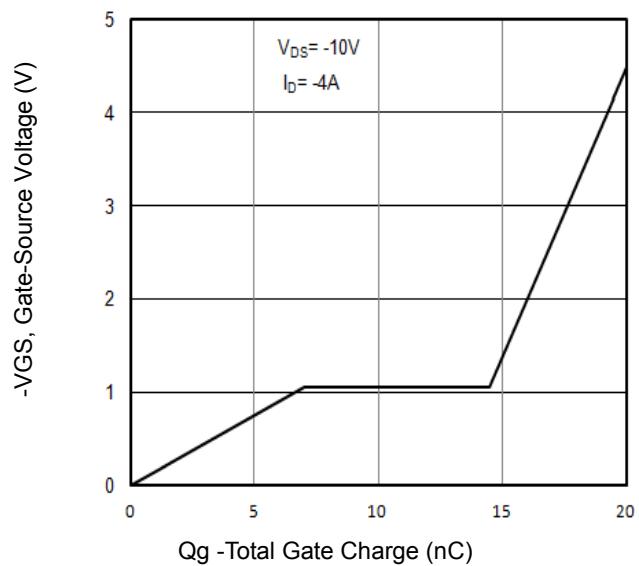


Fig8. Typical Gate Charge Vs.Gate-Source Voltage

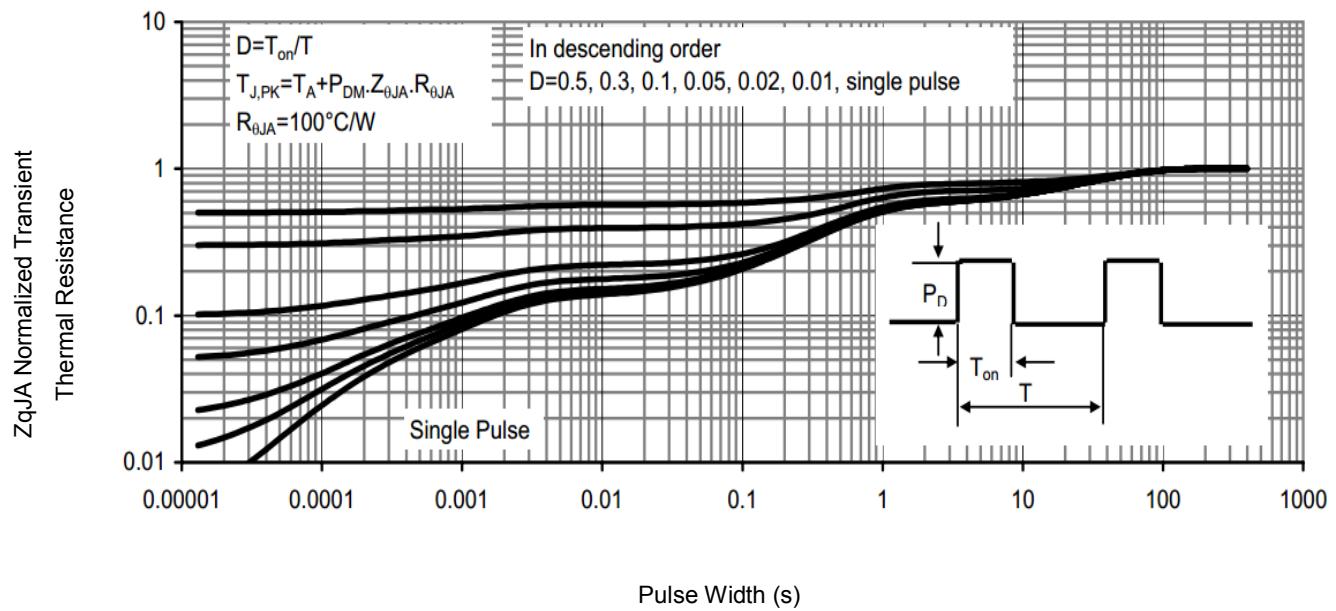


Fig9. Normalized Maximum Transient Thermal Impedance

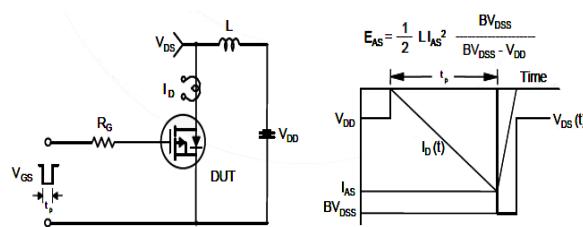


Fig10. Unclamped Inductive Test Circuit and waveforms

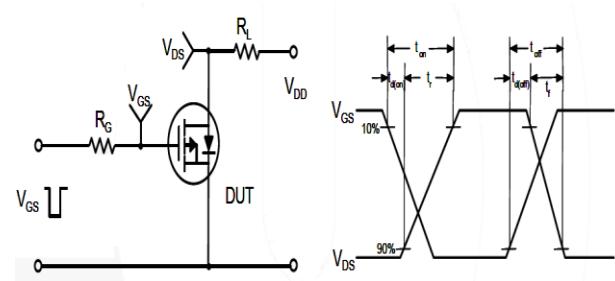


Fig11. Switching Time Test Circuit and waveforms



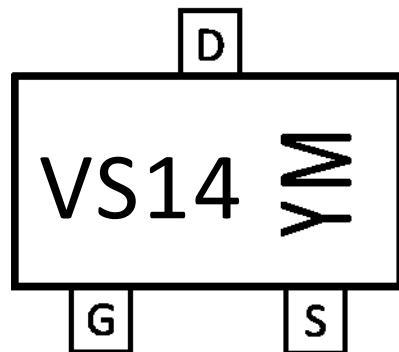
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**Marking Information**



VS14: Part Number

YM: Date Code, Y means assembly year, M means assembly month

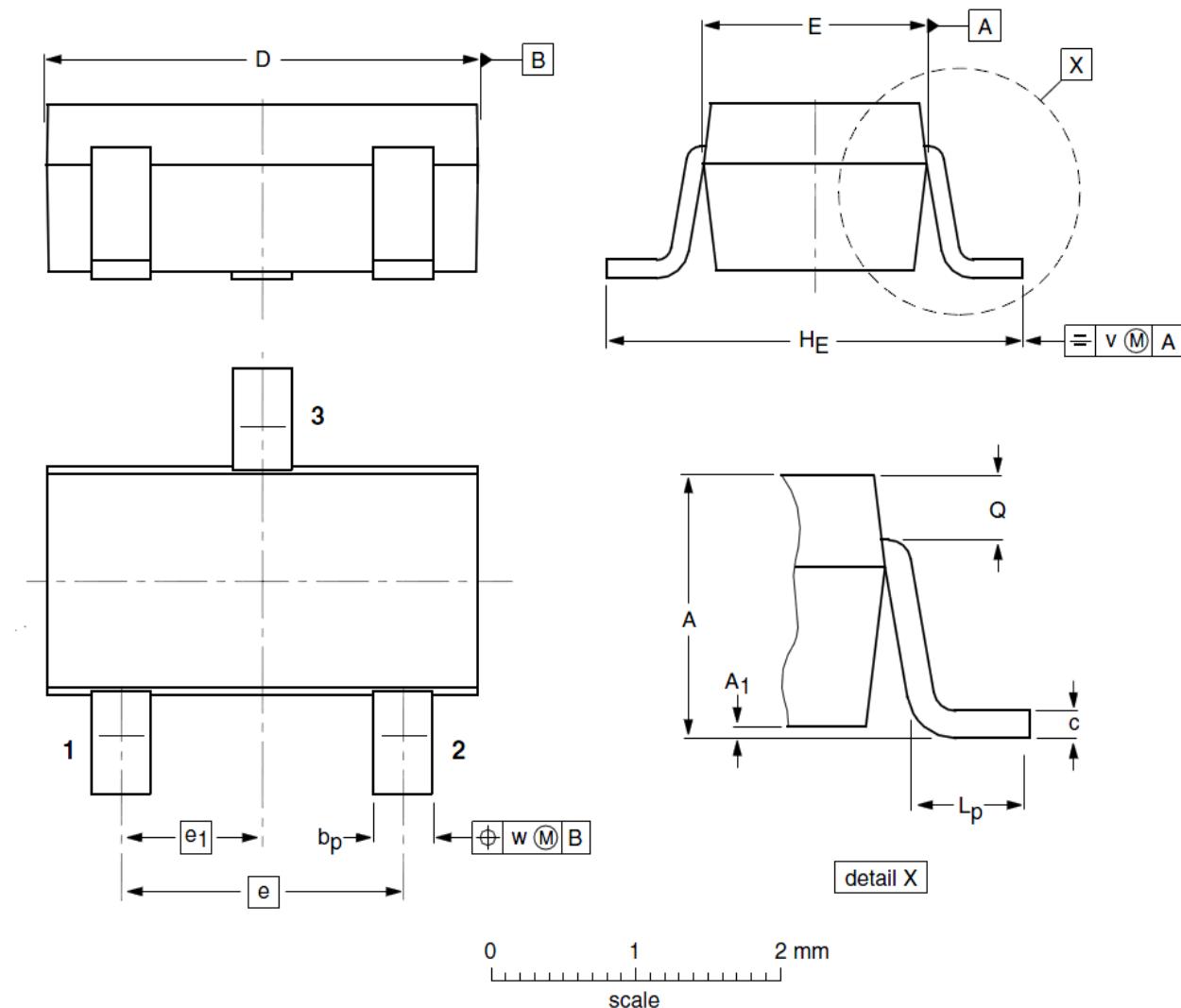


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### SOT23-3L Package Outline Data



| Symbol               | Dimensions (unit: mm) |      |      |
|----------------------|-----------------------|------|------|
|                      | Min                   | Typ  | Max  |
| <b>A</b>             | 0.90                  | 1.07 | 1.25 |
| <b>A<sub>1</sub></b> | 0.01                  | 0.06 | 0.10 |
| <b>b<sub>p</sub></b> | 0.30                  | 0.35 | 0.50 |
| <b>c</b>             | 0.10                  | 0.15 | 0.20 |
| <b>D</b>             | 2.70                  | 2.92 | 3.10 |
| <b>E</b>             | 1.30                  | 1.60 | 1.70 |
| <b>e</b>             | --                    | 1.90 | --   |
| <b>e<sub>1</sub></b> | --                    | 0.95 | --   |
| <b>H<sub>E</sub></b> | 2.50                  | 2.80 | 3.00 |
| <b>L<sub>p</sub></b> | 0.30                  | 0.40 | 0.60 |
| <b>Q</b>             | 0.23                  | 0.29 | 0.33 |
| <b>v</b>             | --                    | 0.20 | --   |
| <b>w</b>             | --                    | 0.20 | --   |

### Customer Service

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